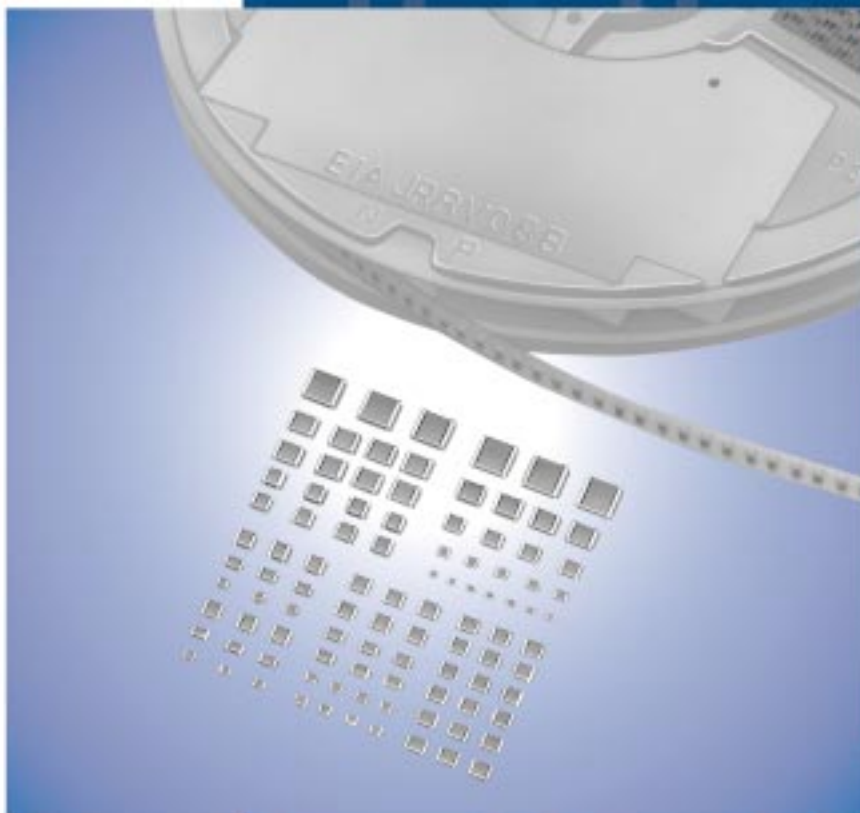


Chip Monolithic Ceramic Capacitors



● Part Numbering

Chip Monolithic Ceramic Capacitors

(Part Number)

GR	M	18	8	B1	1H	102	K	A01	D
①	②	③	④	⑤	⑥	⑦	⑧	⑨	⑩

① Product ID

② Series

Product ID	Code	Series
GR	J	Soft Termination Type
	M	Tin Plated Layer
	4	Only for Information Devices / Tip & Ring
	7	Only for Camera Flash Circuit
GQ	M	High Frequency for Flow/Reflow Soldering
GM	A	Monolithic Microchip
	D	For Bonding
GN	M	Capacitor Array
LL	L	Low ESL Type
	R	Controlled ESR Low ESL Type
	A	8-termination Low ESL Type
	M	10-termination Low ESL Type
GJ	M	High Frequency Low Loss Type
GA	2	For AC250V (r.m.s.)
	3	Safety Standard Certified Type

③ Dimensions (L×W)


Code	Dimensions (L×W)	EIA
02	0.4×0.2mm	01005
03	0.6×0.3mm	0201
05	0.5×0.5mm	0202
08	0.8×0.8mm	0303
0D	0.38×0.38mm	015015
0M	0.9×0.6mm	0302
15	1.0×0.5mm	0402
18	1.6×0.8mm	0603
1M	1.37×1.0mm	0504
21	2.0×1.25mm	0805
22	2.8×2.8mm	1111
31	3.2×1.6mm	1206
32	3.2×2.5mm	1210
42	4.5×2.0mm	1808
43	4.5×3.2mm	1812
52	5.7×2.8mm	2211
55	5.7×5.0mm	2220

④ Dimension (T) (Except GNM)

Code	Dimension (T)
2	0.2mm
3	0.3mm
5	0.5mm
6	0.6mm
7	0.7mm
8	0.8mm
9	0.85mm
A	1.0mm
B	1.25mm
C	1.6mm
D	2.0mm
E	2.5mm
F	3.2mm
M	1.15mm
N	1.35mm
Q	1.5mm
R	1.8mm
S	2.8mm
X	Depends on individual standards.

④ Elements (GNM Only)

Code	Elements
2	2-elements
4	4-elements

Continued on the following page. 

Continued from the preceding page.

⑤ Temperature Characteristics

Temperature Characteristic Codes			Temperature Characteristics			Operating Temperature Range
Code	Public STD Code		Reference Temperature	Temperature Range	Capacitance Change or Temperature Coefficient	
1X	SL *1	JIS	20°C	20 to 85°C	+350 to -1000ppm/°C	-55 to 125°C
2C	CH *1	JIS	20°C	20 to 125°C	0±60ppm/°C	-55 to 125°C
2P	PH *1	JIS	20°C	20 to 85°C	-150±60ppm/°C	-25 to 85°C
2R	RH *1	JIS	20°C	20 to 85°C	-220±60ppm/°C	-25 to 85°C
2S	SH *1	JIS	20°C	20 to 85°C	-330±60ppm/°C	-25 to 85°C
2T	TH *1	JIS	20°C	20 to 85°C	-470±60ppm/°C	-25 to 85°C
3C	CJ *1	JIS	20°C	20 to 125°C	0±120ppm/°C	-55 to 125°C
3P	PJ *1	JIS	20°C	20 to 85°C	-150±120ppm/°C	-25 to 85°C
3R	RJ *1	JIS	20°C	20 to 85°C	-220±120ppm/°C	-25 to 85°C
3S	SJ *1	JIS	20°C	20 to 85°C	-330±120ppm/°C	-25 to 85°C
3T	TJ *1	JIS	20°C	20 to 85°C	-470±120ppm/°C	-25 to 85°C
3U	UJ *1	JIS	20°C	20 to 85°C	-750±120ppm/°C	-25 to 85°C
4C	CK *1	JIS	20°C	20 to 125°C	0±250ppm/°C	-55 to 125°C
5C	C0G *1	EIA	25°C	25 to 125°C	0±30ppm/°C	-55 to 125°C
5G	X8G *1	EIA	25°C	25 to 150°C	0±30ppm/°C	-55 to 150°C
6C	C0H *1	EIA	25°C	25 to 125°C	0±60ppm/°C	-55 to 125°C
6P	P2H *1	EIA	25°C	25 to 85°C	-150±60ppm/°C	-55 to 125°C
6R	R2H *1	EIA	25°C	25 to 85°C	-220±60ppm/°C	-55 to 125°C
6S	S2H *1	EIA	25°C	25 to 85°C	-330±60ppm/°C	-55 to 125°C
6T	T2H *1	EIA	25°C	25 to 85°C	-470±60ppm/°C	-55 to 125°C
7U	U2J *1	EIA	25°C	25 to 125°C *6	-750±120ppm/°C	-55 to 125°C
B1	B *2	JIS	20°C	-25 to 85°C	±10%	-25 to 85°C
B3	B	JIS	20°C	-25 to 85°C	±10%	-25 to 85°C
C7	X7S	EIA	25°C	-55 to 125°C	±22%	-55 to 125°C
C8	X6S	EIA	25°C	-55 to 105°C	±22%	-55 to 105°C
D7	X7T	EIA	25°C	-55 to 125°C	+22, -33%	-55 to 125°C
D8	X6T	EIA	25°C	-55 to 105°C	+22, -33%	-55 to 105°C
E7	X7U	EIA	25°C	-55 to 125°C	+22, -56%	-55 to 125°C
F1	F *2	JIS	20°C	-25 to 85°C	+30, -80%	-25 to 85°C
F5	Y5V	EIA	25°C	-30 to 85°C	+22, -82%	-30 to 85°C
L8	X8L	*3	25°C	-55 to 150°C	+15, -40%	-55 to 150°C
R1	R *2	JIS	20°C	-55 to 125°C	±15%	-55 to 125°C
R3	R	JIS	20°C	-55 to 125°C	±15%	-55 to 125°C
R6	X5R	EIA	25°C	-55 to 85°C	±15%	-55 to 85°C
R7	X7R	EIA	25°C	-55 to 125°C	±15%	-55 to 125°C
R9	X8R	EIA	25°C	-55 to 150°C	±15%	-55 to 150°C
W0	-	-	25°C	-55 to 125°C	±10% *4	-55 to 125°C
					+22, -33% *5	

*1 Please refer to table for Capacitance Change under reference temperature.


*2 Capacitance change is specified with 50% rated voltage applied.

*3 Murata Temperature Characteristic Code.

*4 Apply DC350V bias.

*5 No DC bias.

*6 Rated Voltage 100Vdc max : 25 to 85°C

Continued on the following page. 

Continued from the preceding page.

●Capacitance Change from each temperature

JIS Code

Murata Code	Capacitance Change from 20°C (%)					
	-55°C		-25°C		-10°C	
	Max.	Min.	Max.	Min.	Max.	Min.
1X	-	-	-	-	-	-
2C	0.82	-0.45	0.49	-0.27	0.33	-0.18
2P	-	-	1.32	0.41	0.88	0.27
2R	-	-	1.70	0.72	1.13	0.48
2S	-	-	2.30	1.22	1.54	0.81
2T	-	-	3.07	1.85	2.05	1.23
3C	1.37	-0.90	0.82	-0.54	0.55	-0.36
3P	-	-	1.65	0.14	1.10	0.09
3R	-	-	2.03	0.45	1.35	0.30
3S	-	-	2.63	0.95	1.76	0.63
3T	-	-	3.40	1.58	2.27	1.05
3U	-	-	4.94	2.84	3.29	1.89
4C	2.56	-1.88	1.54	-1.13	1.02	-0.75

EIA Code

Murata Code	Capacitance Change from 25°C (%)					
	-55°C		-30°C		-10°C	
	Max.	Min.	Max.	Min.	Max.	Min.
5C/5G	0.58	-0.24	0.40	-0.17	0.25	-0.11
6C	0.87	-0.48	0.59	-0.33	0.38	-0.21
6P	2.33	0.72	1.61	0.50	1.02	0.32
6R	3.02	1.28	2.08	0.88	1.32	0.56
6S	4.09	2.16	2.81	1.49	1.79	0.95
6T	5.46	3.28	3.75	2.26	2.39	1.44
7U	8.78	5.04	6.04	3.47	3.84	2.21

⑥ Rated Voltage


Code	Rated Voltage
0E	DC2.5V
0G	DC4V
0J	DC6.3V
1A	DC10V
1C	DC16V
1E	DC25V
YA	DC35V
1H	DC50V
2A	DC100V
2D	DC200V
2E	DC250V
YD	DC300V
2H	DC500V
2J	DC630V
3A	DC1kV
3D	DC2kV
3F	DC3.15kV
BB	DC350V (for Camera Flash Circuit)
E2	AC250V
GC	X1/Y2; AC250V (Safety Standard Certified Type GC)
GF	Y2, X1/Y2; AC250V (Safety Standard Certified Type GF)
GD	Y3; AC250V (Safety Standard Certified Type GD)
GB	X2; AC250V (Safety Standard Certified Type GB)

⑦ Capacitance

Expressed by three-digit alphanumerics. The unit is picofarad (pF). The first and second figures are significant digits, and the third figure expresses the number of zeros which follow the two numbers. If there is a decimal point, it is expressed by the capital letter "R." In this case, all figures are significant digits.

Ex.)

Code	Capacitance
R50	0.5pF
1R0	1.0pF
100	10pF
103	10000pF

Continued on the following page. 

Please check the MURATA home page (<http://www.murata.com/>) if you cannot find the part number in the catalog.

Continued from the preceding page.

⑧ Capacitance Tolerance

Code	Capacitance Tolerance	TC	Series	Capacitance Step	
W	±0.05pF	CΔ	GRM/GJM	≤9.9pF	0.1pF
B	±0.1pF	CΔ	GRM/GJM	≤9.9pF	0.1pF
			GQM	≤1pF	0.1pF
C	±0.25pF	CΔ	GRM/GJM	≤9.9pF	0.1pF
		except CΔ	GRM	≤5pF	* 1pF
		CΔ	GQM	≤1pF	0.1pF
				1.1 to 9.9pF	1pF Step and E24 Series
D	±0.5pF	CΔ	GRM/GJM	5.1 to 9.9pF	0.1pF
		except CΔ	GRM	5.1 to 9.9pF	* 1pF
		CΔ	GQM	5.1 to 9.9pF	1pF Step and E24 Series
G	±2%	CΔ	GJM	≥10pF	E12 Series
		CΔ	GQM	≥10pF	E24 Series
J	±5%	CΔ, SL, U2J	GRM/GA3	≥10pF	E12 Series
		CΔ	GQM/GJM	≥10pF	E24 Series
K	±10%	B, R, X7R, X5R, ZLM	GRJ/GRM/GR7/GA3	E6 Series	
		C0G	GNM	E6 Series	
		B, R, X7R, X5R, ZLM	GR4, GMD	E12 Series	
M	±20%	B, R, X7R, X7S	GRM/GMA	E6 Series	
		X5R, X7R, X7S	GNM	E3 Series	
		X7R	GA2	E3 Series	
		X5R, X7R, X7S, X6S	LLL/LLR/LLA/LLM	E3 Series	
Z	+80%, -20%	F, Y5V	GRM	E3 Series	
R	Depends on individual standards.				

* E24 series is also available.

⑨ Individual Specification Code (Except LLR)

Expressed by three figures.

⑨ ESR (LLR Only)

Code	ESR
E01	100mΩ
E03	220mΩ
E05	470mΩ
E07	1000mΩ

⑩ Packaging

Code	Packaging
L	ø180mm Embossed Taping
D	ø180mm Paper Taping
E	ø180mm Paper Taping (LLL15)
K	ø330mm Embossed Taping
J	ø330mm Paper Taping
F	ø330mm Paper Taping (LLL15)
B	Bulk
C	Bulk Case
T	Bulk Tray

Please check the MURATA home page (<http://www.murata.com/>) if you cannot find the part number in the catalog.

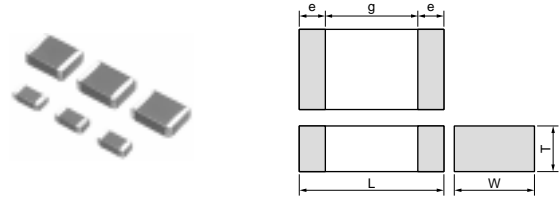
Chip Monolithic Ceramic Capacitors (Medium Voltage)



For Information Devices GR4 Series

■ Features

1. These items are designed specifically for telecommunications devices (IEEE802.3) in Ethernet LAN and primary-secondary coupling for DC-DC converters.
2. A new monolithic structure for small, high capacitance capable of operating at high voltage levels
3. Sn-plated external electrodes realize good solderability.
4. Only for reflow soldering



Part Number	Dimensions (mm)				
	L	W	T	e min.	g min.
GR442Q	4.5 ±0.3	2.0 ±0.2	1.5 +0, -0.3	0.3	2.5
GR443D	4.5 ±0.4	3.2 ±0.3	2.0 +0, -0.3		
GR443Q			1.5 +0, -0.3		
GR455D	5.7 ±0.4	5.0 ±0.4	2.0 +0, -0.3		3.2

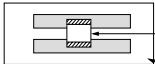
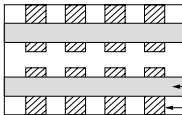
■ Applications

1. Ideal for use on telecommunications devices in Ethernet LAN
2. Ideal for use as primary-secondary coupling for DC-DC converters


Do not use these products in any Automotive Power train or Safety equipment including Battery charger for Electric Vehicles and Plug-in Hybrid. Only Murata products clearly stipulated as "for Automotive use" can be used for automobile applications such as Power train and Safety equipment.

Part Number	Rated Voltage (V)	TC Code (Standard)	Capacitance (pF)	Length L (mm)	Width W (mm)	Thickness T (mm)	Electrode g min. (mm)	Electrode e (mm)
GR442QR73D101KW01L	DC2000	X7R (EIA)	100 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D121KW01L	DC2000	X7R (EIA)	120 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D151KW01L	DC2000	X7R (EIA)	150 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D181KW01L	DC2000	X7R (EIA)	180 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D221KW01L	DC2000	X7R (EIA)	220 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D271KW01L	DC2000	X7R (EIA)	270 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D331KW01L	DC2000	X7R (EIA)	330 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D391KW01L	DC2000	X7R (EIA)	390 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D471KW01L	DC2000	X7R (EIA)	470 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D561KW01L	DC2000	X7R (EIA)	560 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D681KW01L	DC2000	X7R (EIA)	680 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D821KW01L	DC2000	X7R (EIA)	820 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D102KW01L	DC2000	X7R (EIA)	1000 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D122KW01L	DC2000	X7R (EIA)	1200 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR442QR73D152KW01L	DC2000	X7R (EIA)	1500 ±10%	4.5	2.0	1.5	2.5	0.3 min.
GR443QR73D182KW01L	DC2000	X7R (EIA)	1800 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443QR73D222KW01L	DC2000	X7R (EIA)	2200 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443QR73D272KW01L	DC2000	X7R (EIA)	2700 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443QR73D332KW01L	DC2000	X7R (EIA)	3300 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443QR73D392KW01L	DC2000	X7R (EIA)	3900 ±10%	4.5	3.2	1.5	2.5	0.3 min.
GR443DR73D472KW01L	DC2000	X7R (EIA)	4700 ±10%	4.5	3.2	2.0	2.5	0.3 min.
GR455DR73D103KW01L	DC2000	X7R (EIA)	10000 ±10%	5.7	5.0	2.0	3.2	0.3 min.

GR4 Series Specifications and Test Methods

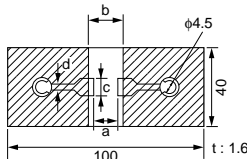
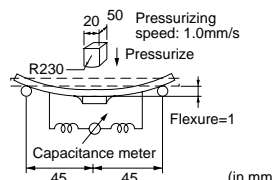
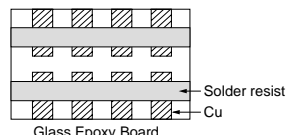
No.	Item		Specifications	Test Method												
1	Operating Temperature Range		−55 to +125℃	—												
2	Appearance		No defects or abnormalities	Visual inspection												
3	Dimensions		Within the specified dimensions	Using calipers and micrometers												
4	Dielectric Strength		No defects or abnormalities	No failure should be observed when voltage in the table is applied between the terminations, provided the charge/discharge current is less than 50mA. <table><tr><th>Rated Voltage</th><th>Test Voltage</th><th>Time</th></tr><tr><td rowspan="2">DC2kV</td><td>120% of the rated voltage</td><td>60±1 sec.</td></tr><tr><td>AC1500V(r.m.s.)</td><td>60±1 sec.</td></tr></table>	Rated Voltage	Test Voltage	Time	DC2kV	120% of the rated voltage	60±1 sec.	AC1500V(r.m.s.)	60±1 sec.				
Rated Voltage	Test Voltage	Time														
DC2kV	120% of the rated voltage	60±1 sec.														
	AC1500V(r.m.s.)	60±1 sec.														
5	Pulse Voltage		No self healing breakdowns or flash-overs have taken place in the capacitor.	10 impulses of alternating polarity are subjected. (5 impulses for each polarity) The interval between impulses is 60 sec. Applied Pulse: 1.2/50μs Applied Voltage: 2.5kVo-p												
6	Insulation Resistance (I.R.)		More than 6,000MΩ	The insulation resistance should be measured with DC500±50V and within 60±5 sec. of charging.												
7	Capacitance		Within the specified tolerance	The capacitance/D.F. should be measured at a frequency of 1±0.2kHz and a voltage of AC1±0.2V(r.m.s.)												
8	Dissipation Factor (D.F.)		0.025 max.													
9	Capacitance Temperature Characteristics		Cap. Change within ±15% (Temp. Range: −55 to +125℃)	The capacitance measurement should be made at each step specified in the Table. <table><tr><th>Step</th><th>Temperature (℃)</th></tr><tr><td>1</td><td>25±2</td></tr><tr><td>2</td><td>Min. Operating Temp.±3</td></tr><tr><td>3</td><td>25±2</td></tr><tr><td>4</td><td>Max. Operating Temp.±2</td></tr><tr><td>5</td><td>25±2</td></tr></table> <p>•Pretreatment Perform a heat treatment at 150^{±5}℃ for 60±5 min. and then let sit for 24±2 hrs. at room condition.*</p>	Step	Temperature (℃)	1	25±2	2	Min. Operating Temp.±3	3	25±2	4	Max. Operating Temp.±2	5	25±2
Step	Temperature (℃)															
1	25±2															
2	Min. Operating Temp.±3															
3	25±2															
4	Max. Operating Temp.±2															
5	25±2															
10	Adhesive Strength of Termination		No removal of the terminations or other defect should occur.	Solder the capacitor to the testing jig (glass epoxy board) shown in Fig. 1. Then apply 10N force in the direction of the arrow. The soldering should be done using the reflow method and should be conducted with care so that the soldering is uniform and free of defects such as heat shock. <div><p>10N, 10±1s Glass Epoxy Board</p></div> <p>Fig. 1</p>												
11	Vibration Resistance	Appearance	No defects or abnormalities	Solder the capacitor to the test jig (glass epoxy board). The capacitor should be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, should be traversed in approximately 1 min. This motion should be applied for a period of 2 hrs. in each of 3 mutually perpendicular directions (total of 6 hrs.). <div><p>Solder resist Cu Glass Epoxy Board</p></div>												
		Capacitance	Within the specified tolerance													
		D.F.	0.025 max.													

* "Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Continued on the following page. 

GR4 Series Specifications and Test Methods

Continued from the preceding page.

No.	Item		Specifications	Test Method																							
12	Deflection		No marking defects	<p>Solder the capacitor to the testing jig (glass epoxy board) shown in Fig. 2.</p> <p>Then apply a force in the direction shown in Fig. 3.</p> <p>The soldering should be done using the reflow method and should be conducted with care so that the soldering is uniform and free of defects such as heat shock.</p> <div><p>Fig. 2</p><table><tr><th>LXW (mm)</th><th colspan="4">Dimension (mm)</th></tr><tr><th></th><th>a</th><th>b</th><th>c</th><th>d</th></tr><tr><td>4.5X2.0</td><td>3.5</td><td>7.0</td><td>2.4</td><td rowspan="3">1.0</td></tr><tr><td>4.5X3.2</td><td>3.5</td><td>7.0</td><td>3.7</td></tr><tr><td>5.7X5.0</td><td>4.5</td><td>8.0</td><td>5.6</td></tr></table></div> <div><p>Fig. 3</p></div>	LXW (mm)	Dimension (mm)					a	b	c	d	4.5X2.0	3.5	7.0	2.4	1.0	4.5X3.2	3.5	7.0	3.7	5.7X5.0	4.5	8.0	5.6
			LXW (mm)		Dimension (mm)																						
	a	b	c	d																							
4.5X2.0	3.5	7.0	2.4	1.0																							
4.5X3.2	3.5	7.0	3.7																								
5.7X5.0	4.5	8.0	5.6																								
13	Solderability of Termination	75% of the terminations are to be soldered evenly and continuously.	<p>Immerse the capacitor in a solution of ethanol (JIS-K-8101) and rosin (JIS-K-5902) (25% rosin in weight proportion). Immerse in solder solution for 2±0.5 sec.</p> <p>Immersing speed: 25±2.5mm/s</p> <p>Temp. of solder: 245±5°C Lead Free Solder (Sn-3.0Ag-0.5Cu) 235±5°C H60A or H63A Eutectic Solder</p>																								
14	Resistance to Soldering Heat	Appearance	No marking defects	<p>Preheat the capacitor as in table.</p> <p>Immerse the capacitor in solder solution at 260±5°C for 10±1 sec. Let sit at room condition* for 24±2 hrs., then measure.</p> <p>•Immersing speed: 25±2.5mm/s</p> <p>•Pretreatment</p> <p>Perform a heat treatment at 150±, °C for 60±5 min. and then let sit for 24±2 hrs. at room condition.*</p> <p>*Preheating</p> <table><tr><th>Step</th><th>Temperature</th><th>Time</th></tr><tr><td>1</td><td>100 to 120°C</td><td>1 min.</td></tr><tr><td>2</td><td>170 to 200°C</td><td>1 min.</td></tr></table>	Step	Temperature	Time	1	100 to 120°C	1 min.	2	170 to 200°C	1 min.														
		Step	Temperature		Time																						
		1	100 to 120°C		1 min.																						
		2	170 to 200°C		1 min.																						
		Capacitance Change	Within ±10%																								
D.F.	0.025 max.																										
I.R.	More than 1,000MΩ																										
Dielectric Strength	In accordance with item No.4																										
15	Temperature Cycle	Appearance	No marking defects	<p>Fix the capacitor to the supporting jig (glass epoxy board) shown in Fig. 4.</p> <p>Perform the 5 cycles according to the 4 heat treatments listed in the following table.</p> <p>Let sit for 24±2 hrs. at room condition,* then measure.</p> <table><tr><th>Step</th><th>Temperature (°C)</th><th>Time (min.)</th></tr><tr><td>1</td><td>Min. Operating Temp.±3</td><td>30±3</td></tr><tr><td>2</td><td>Room Temp.</td><td>2 to 3</td></tr><tr><td>3</td><td>Max. Operating Temp.±2</td><td>30±3</td></tr><tr><td>4</td><td>Room Temp.</td><td>2 to 3</td></tr></table>	Step	Temperature (°C)	Time (min.)	1	Min. Operating Temp.±3	30±3	2	Room Temp.	2 to 3	3	Max. Operating Temp.±2	30±3	4	Room Temp.	2 to 3								
		Step	Temperature (°C)		Time (min.)																						
		1	Min. Operating Temp.±3		30±3																						
		2	Room Temp.		2 to 3																						
		3	Max. Operating Temp.±2		30±3																						
4	Room Temp.	2 to 3																									
Capacitance Change	Within ±15%																										
D.F.	0.05 max.																										
I.R.	More than 3,000MΩ																										
Dielectric Strength	In accordance with item No.4																										
16	Humidity (Steady State)	Appearance	No marking defects	<p>Let the capacitor sit at 40±2°C and relative humidity of 90 to 95% for 500^{±24}hrs.</p> <p>Remove and let sit for 24±2 hrs. at room condition,* then measure.</p> <p>•Pretreatment</p> <p>Perform a heat treatment at 150±, °C for 60±5 min. and then let sit for 24±2 hrs. at room condition.*</p> <div><p>Fig. 4</p></div>																							
		Capacitance Change	Within ±15%																								
		D.F.	0.05 max.																								
		I.R.	More than 1,000MΩ																								
		Dielectric Strength	In accordance with item No.4																								

* "Room condition" Temperature: 15 to 35°C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Continued on the following page. ➤

For General Purpose
GRM/GRJ Series


Only for Applications
GR4 Series

AC250V Type
GA2 Series

Safety Standard
Certified GA3 Series

Product Information

GR4 Series Specifications and Test Methods

 Continued from the preceding page.

No.	Item		Specifications	Test Method
17	Life	Appearance	No marking defects	Apply 110% of the rated voltage for 1,000 \pm 4 ⁸ hrs. at maximum operating temperature \pm 3 $^{\circ}$ C. Remove and let sit for 24 \pm 2 hrs. at room condition,* then measure. The charge/discharge current is less than 50mA. •Pretreatment Apply test voltage for 60 \pm 5 min. at test temperature. Remove and let sit for 24 \pm 2 hrs. at room condition.*
		Capacitance Change	Within \pm 20%	
		D.F.	0.05 max.	
		I.R.	More than 2,000M Ω	
		Dielectric Strength	In accordance with item No.4	

* "Room condition" Temperature: 15 to 35 $^{\circ}$ C, Relative humidity: 45 to 75%, Atmospheric pressure: 86 to 106kPa

Mouser Electronics

Authorized Distributor

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Murata:

<u>GR443QR7LB222KW01L</u>	<u>GR431BR7LA102KW01L</u>	<u>GR442QR7LB101KW01L</u>	<u>GR442QR7LB152KW01L</u>
<u>GR433QR73D102KW01L</u>	<u>GR431BR7LA471KW01L</u>	<u>GR442QR7LB102KW01L</u>	<u>GR442QR7LB151KW01L</u>
<u>GR442QR7LB221KW01L</u>	<u>GR442QR7LB331KW01L</u>	<u>GR442QR7LB471KW01L</u>	<u>GR442QR7LB681KW01L</u>
<u>GR443DR7LB472KW01L</u>	<u>GR443QR7LB182KW01L</u>	<u>GR443QR7LB272KW01L</u>	<u>GR443QR7LB332KW01L</u>
<u>GR443QR7LB392KW01L</u>	<u>GR442QR7LB121KW01L</u>	<u>GR442QR7LB122KW01L</u>	<u>GR442QR7LB181KW01L</u>
<u>GR442QR7LB271KW01L</u>	<u>GR442QR7LB391KW01L</u>	<u>GR442QR7LB561KW01L</u>	<u>GR442QR7LB821KW01L</u>
<u>GR431BR7LA102KW66L</u>			